

### General Description

It's mainly suitable for battery pack or power management in cell phone, and PDA.

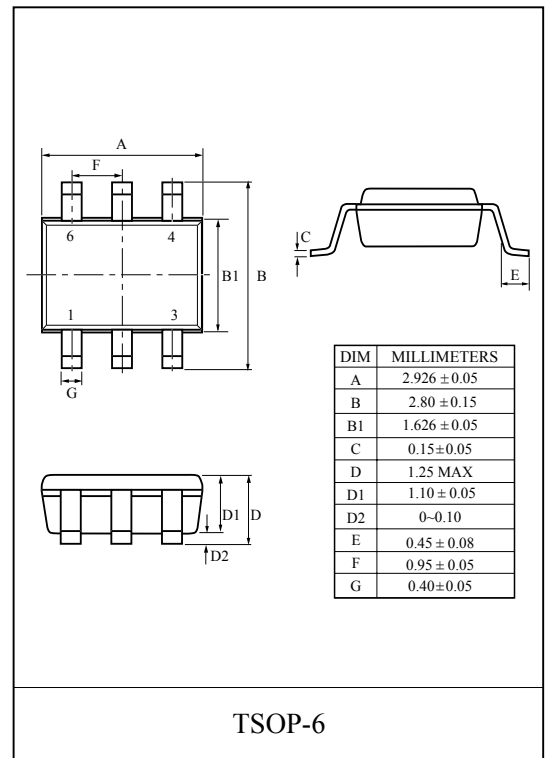
### FEATURES

- $V_{DSS} = -20V$ ,  $I_D = -4.5A$ .
- Drain-Source ON Resistance.
  - :  $R_{DS(ON)} = 60m\ \Omega$  (Max.) @  $V_{GS} = -4.5V, I_D = -4.5A$
  - :  $R_{DS(ON)} = 110m\ \Omega$  (Max.) @  $V_{GS} = -2.5V, I_D = -3.3A$
- Super High Dense Cell Design for Extremely Low  $R_{DS(ON)}$

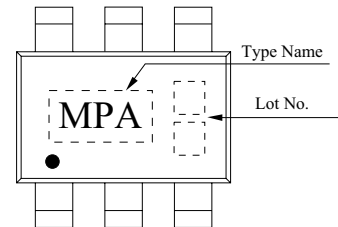
### MAXIMUM RATING (Ta=25 °C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		$V_{DSS}$	-20	V
Gate-Source Voltage		$V_{GSS}$	$\pm 12$	V
Drain Current	DC	$I_D^*$	$\pm 4.5$	A
	Pulsed	$I_{DP}^*$	$\pm 16$	
Continuous Source Current		$I_S$	-1.3	A
Drain Power Dissipation	Ta=25 °C	$P_D^*$	2.0	W
	Ta=70 °C		1.3	
Maximum Junction Temperature		$T_j$	150	°C
Storage Temperature Range		$T_{stg}$	-55~150	°C
Thermal Resistance, Junction to Ambient		$R_{thJA}^*$	62.5	°C/W

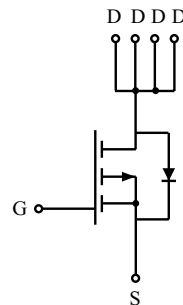
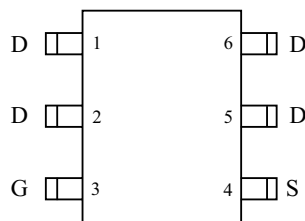
\* : Surface Mounted on 1" × 1" FR4 Board, t ≤ 5sec.



### Marking



### PIN CONNECTION (TOP VIEW)



# KMA4D5P20X

## ELECTRICAL CHARACTERISTICS (Ta=25°C)

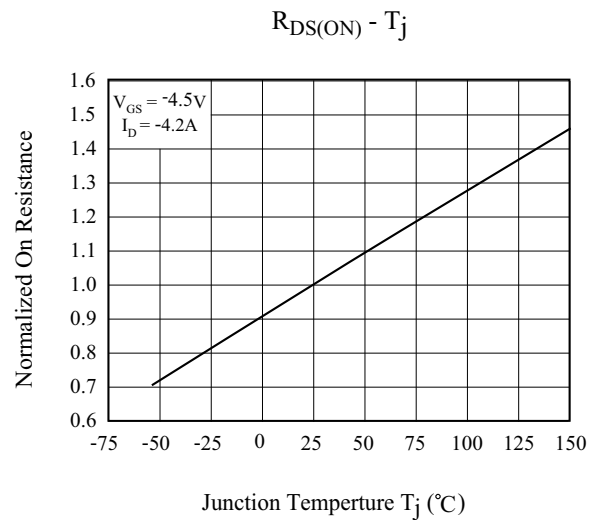
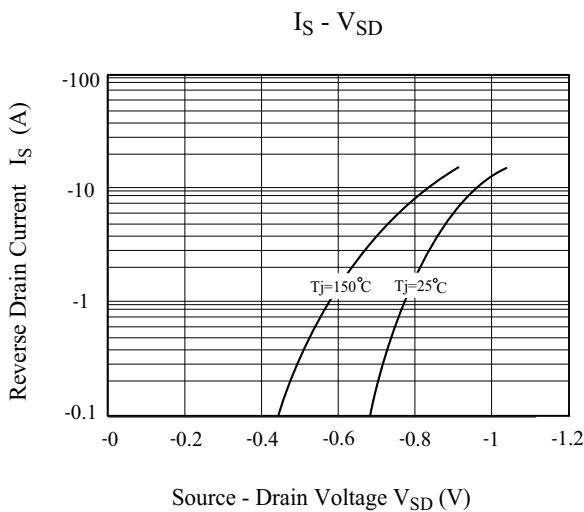
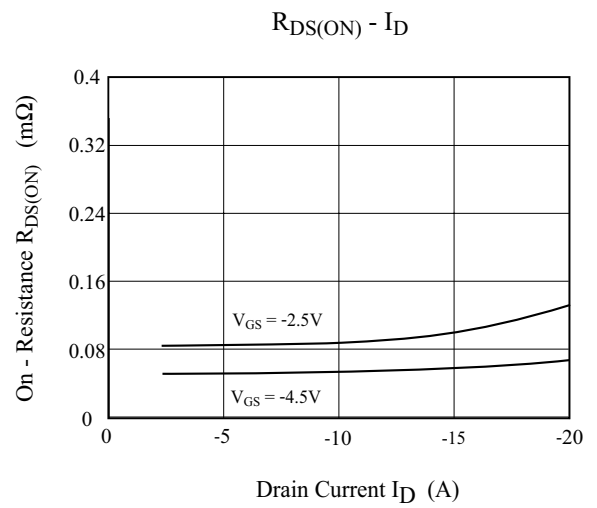
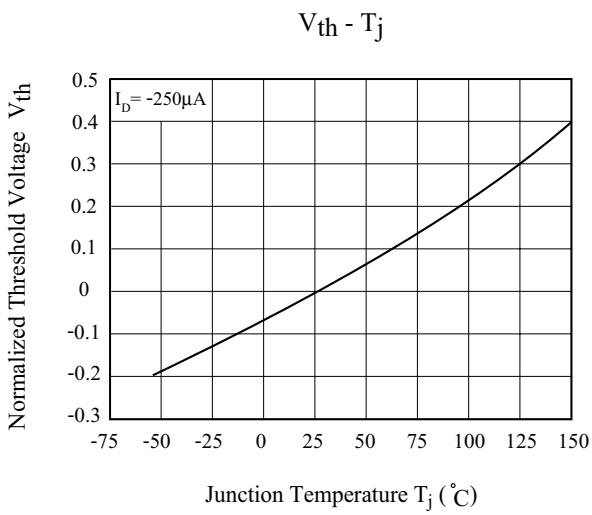
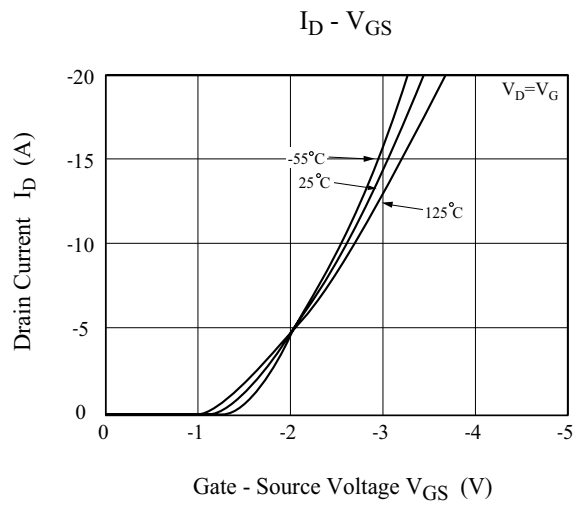
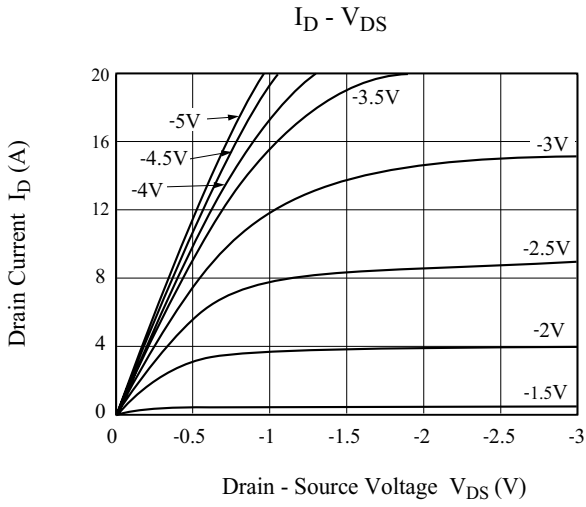
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=-250\mu A, V_{GS}=0V$	-20	-	-	V
Drain Cut-off Current	$I_{DSS}$	$V_{GS}=0V, V_{DS}=-20V$	-	-	-1	$\mu A$
		$V_{GS}=0V, V_{DS}=-16V, T_j=70^\circ C$ (Note 3)	-	-	-5	
Gate Threshold Voltage	$V_{th}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.6	-	-1.3	V
Gate Leakage Current	$I_{GSS}$	$V_{GS}=\pm 12V, V_{DS}=0V$	-	-	$\pm 100$	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS}=-4.5V, I_D=-4.5A$ (Note 2)	-	49	60	m $\Omega$
		$V_{GS}=-2.5V, I_D=-3.3A$ (Note 2)	-	85	110	
Forward Transconductance	$g_{fs}$	$V_{DS}=-5V, I_D=-4.5A$ (Note 2)	-	7	-	S
<b>Dynamic</b> (Note 3)						
Total Gate Charge	$Q_g$	$V_{DS}=-10V, R_D=2.2\Omega$ $V_{GS}=-4.5V$ (Fig.1)	-	8.5	-	nC
Gate-Source Charge	$Q_{gs}$		-	1.8	-	
Gate-Drain Charge	$Q_{gd}$		-	2.9	-	
Turn-on Delay time	$t_{d(on)}$	$V_{DS}=-10V, R_D=2.2\Omega$ $V_{GS}=-4.5V, R_G=6\Omega$ (Fig.2)	-	12	-	ns
Turn-on Rise time	$t_r$		-	32	-	
Turn-off Delay time	$t_{d(off)}$		-	64	-	
Turn-off Fall time	$t_f$		-	40	-	
<b>Source-Drain Diode Ratings</b>						
Continuous Source Current	$I_S$	$V_{GS} < V_{th}$ (Note 1)	-	-	-1.3	A
Diode Forward Voltage	$V_{SD}$	$I_S=-4.5A, V_{GS}=0V$ (Note 2)	-	-	-1.3	V

Note 1) Based on thermal dissipation from junction to ambient while mounted on a 1" × 1" FR4 Board.

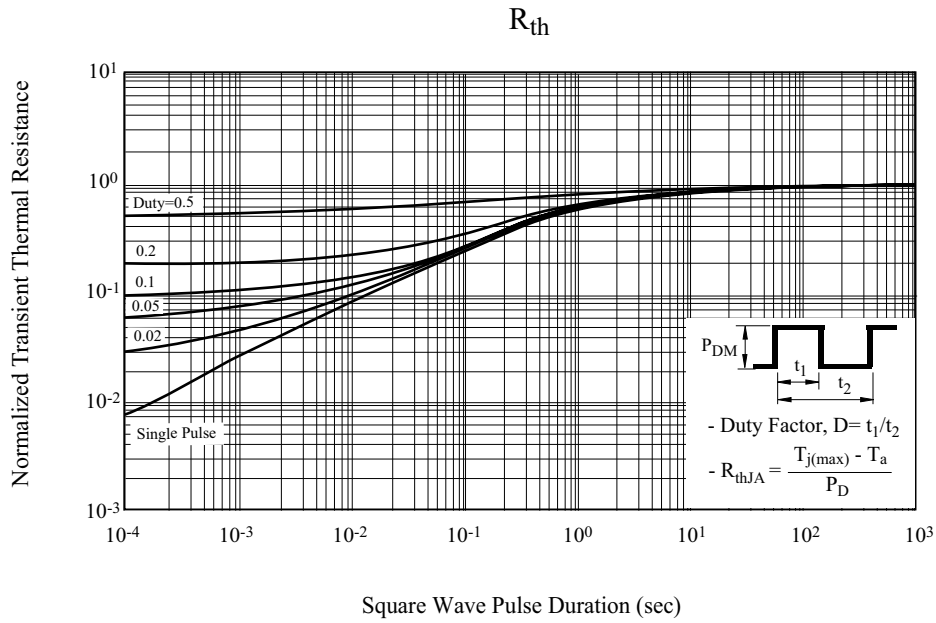
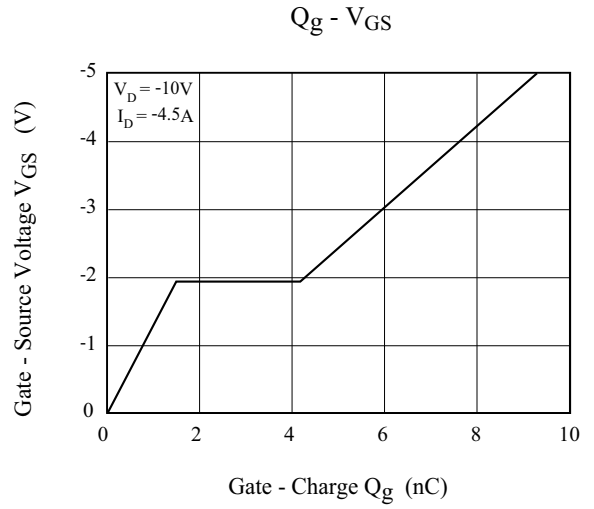
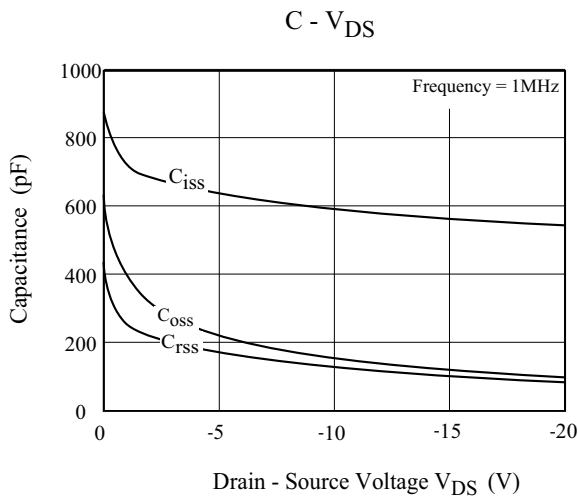
Note 2) Pulse test : Pulse width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$

Note 3) Guaranteed by design, not subject to production testing.

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Fig. 1 Gate Charge

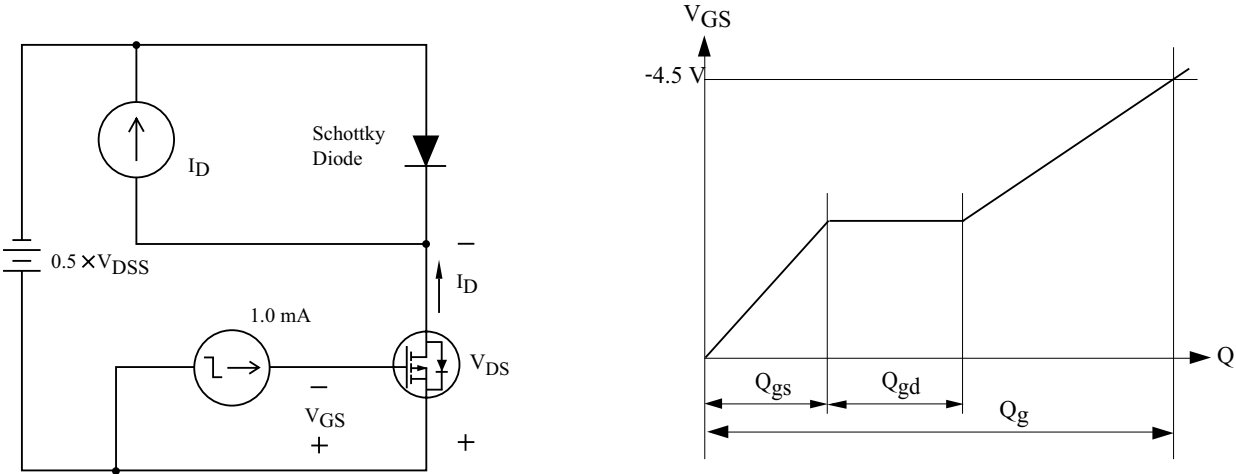


Fig. 2 Resistive Load Switching

